



IFW

2812

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Schmitz	Examiner:	Cheung, Lee
Application No.:	10/529,962	Group Art Unit:	2812
Filed:	March 31, 2005	Docket No.:	BE020028 US (VLSI.470PA)
Title:	METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE WITH A SILICON BODY PROVIDED WITH FIELD ISOLATION REGIONS CONSISTING OF GROOVES FILLED WITH ISOLATING MATERIAL		

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence and the papers, as described hereinabove, are being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 22, 2006.

By:

Kelly S. Waltigney
Kelly S. Waltigney

OFFICE ACTION RESPONSE AND AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Customer No.
24738

Dear Sir:

In response to the non-final Office Action dated February 21, 2006, please consider the following amendments and remarks.

Amendments to the Claims are reflected in the listing of claims which begins on page 2, amendments to the Drawings are discussed at page 5, and the Remarks follow on page 6.